

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
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IN SEOB BAE	08/14/2018
JEA WON KIM	08/14/2018
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Property Type	Number
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Total Attachments: 2	
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PATENT APPLICATION

ASSIGNMENT

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Title of Invention: METHOD OF MANUFACTURING SEMICONDUCTOR PACKAGE
SUBSTRATE AND SEMICONDUCTOR PACKAGE SUBSTRATE
MANUFACTURED USING THE SAME

Application No.: 16/117,923

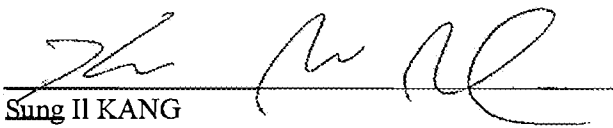
Filing Date: August 30, 2018

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In the event that the patent application filing date or application number is not known at the time this document is executed, Assignors hereby grant permission to the attorneys of record in the patent application to fill in the filing date and/or application number above, and to record this assignment after such information is added.

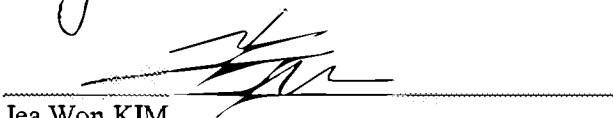
EXECUTED this 14 day of AUG, 2018


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